

NuVoice[®]
N575F145
Data Sheet

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1 GENERAL DESCRIPTION

The N575F145 is a system-on-chip product optimized for low power, audio record and playback with an embedded ARM® Cortex™-M0 32-bit microcontroller core.

The N575F145 embeds a Cortex™-M0 core running up to 49 MHz with 145 KBytes of non-volatile flash memory and 12 KBytes of embedded SRAM. It also comes equipped with a variety of peripheral devices, such as Timers, Watchdog Timer (WDT), Real-time Clock (RTC), Peripheral Direct Memory Access (PDMA), a variety of serial interfaces (UART, SPI/SSP, I²C, I²S), PWM modulators, GPIO, Analog Comparator, Low Voltage Detector and Brown-out detector.

The N575F145 comes equipped with a rich set of power saving modes including a Deep Power Down (DPD) mode drawing less than 1µA. A micro-power 16 KHz oscillator can periodically wake up the device from deep power down to check for other events. A Standby Power Down (SPD) mode can maintain a real time clock function at less than 10 µA.

For audio functionality the N575F145 includes a Sigma-Delta ADC with 92 dB SNR performance coupled with a Programmable Gain Amplifier (PGA) capable of a maximum gain of 61 dB to enable direct connection of a microphone. Audio output is provided by a Differential Class D amplifier (DPWM) that can deliver 1W¹ of power to an 8Ω speaker.

The N575F145 provides eight analog enabled general purpose IO pins (GPIO). These pins can be configured to connect to an analog comparator, can be configured as analog current sources or can be routed to the SDADC for analog conversion. They can also be used as a relaxation oscillator to perform capacitive touch sensing.

¹ We suggest implementing thermal protection by utilizing the Temperature Alarm; for details please refer to Temperature Alarm in Design Guide.

2 FEATURES

- Core
 - ARM® Cortex™-M0 core runs up to 49 MHz.
 - One 24-bit System tick timer for operating system support.
 - Supports a variety of low power sleep and power down modes.
 - Single-cycle 32-bit hardware multiplier.
 - NVIC (Nested Vector Interrupt Controller) for 32 interrupt inputs, each with 4-levels of priority.
 - Serial Wire Debug (SWD) support with 2 watchpoints/4 breakpoints.
- Power Management
 - Wide operating voltage range from 2.4V to 5.5V.
 - Power management Unit (PMU) providing four levels of power control.
 - Deep Power Down (DPD) mode with sub micro-amp leakage (<1μA).
 - Wakeup from Deep Power Down via dedicated WAKEUP pin or timed operation from internal low power 16 KHz oscillator.
 - Standby mode with limited RAM retention and RTC operation (<10μA).
 - Wakeup from Standby can be from any GPIO interrupt, RTC or BOD.
 - Sleep mode with minimal dynamic power consumption.
 - 3V LDO for operation of external 3V devices such as serial flash.
- Flash EPROM Memory
 - 145 KBytes Flash EPROM for program code and data storage.
 - 4 KBytes of flash can be configured as boot sector for ISP loader.
 - Support In-system program (ISP) and In-circuit program (ICP) application code update
 - 1 KBytes page erase for flash
 - Configurable boundary to delineate code and data flash.
 - Support 2 wire In-circuit Programming (ICP) update from SWD ICE interface
- SRAM Memory
 - 12 KBytes embedded SRAM.
- Clock Control
 - One high speed and two low speed oscillators providing flexible selection for different applications. No external components necessary.
 - Built-in trimmable oscillator with range of 16 ~ 49 MHz. Factory trimmed within 1% to settings of 49.152 MHz and 32.768 MHz. User trimmable with in-built frequency measurement block (OSCFM) using reference clock of 32 KHz crystal or external reference source.
 - Ultra-low power (<1uA) 16 KHz oscillator for watchdog and wakeup from power-down or sleep operation.
 - External 32 KHz crystal input for RTC function and low power system operation.
- GPIO
 - Four I/O modes:
 - ◆ Quasi bi-direction
 - ◆ Push-Pull output
 - ◆ Open-Drain output
 - ◆ Input only with high impedance
 - TTL/Schmitt trigger input selectable.
 - I/O pin can be configured as interrupt source with edge/level setting.
 - Switchable pull-up.
- Audio Analog to Digital converter
 - Sigma Delta ADC with configurable decimation filter and 16 bit output.

- 92 dB Signal-to-Noise (SNR) performance.
- Programmable gain amplifier with 32 steps from -12 to 35.25 dB in 0.75 dB steps.
- Boost gain stage of 26 dB, giving maximum total gain of 61 dB.
- Input selectable from dedicated MIC pins or analog enabled GPIO.
- Programmable biquad filter to support multiple sample rates from 8 ~ 32 KHz.
- DMA support for minimal CPU intervention.
- Differential Audio PWM Output (DPWM)
 - Direct connection of speaker
 - 1W drive capability into 8Ω load
 - Configurable up-sampling to support sample rates from 8 ~ 32 KHz
 - DMA support for minimal CPU intervention.
- Timers
 - Two timers with 8-bit pre-scalar and 24-bit resolution.
 - Counter auto reload.
- Watch Dog Timer
 - Default ON/OFF by configuration setting
 - Multiple clock sources
 - 8 selectable time out period from micro seconds to seconds (depending on clock source)
 - WDT can wake up power down/sleep.
 - Interrupt or reset selectable on watchdog time-out.
- RTC
 - Real Time Clock counter (second, minute, hour) and calendar counter (day, month, year)
 - Alarm registers (second, minute, hour, day, month, year)
 - Selectable 12-hour or 24-hour mode
 - Automatic leap year recognition
 - Time tick and alarm interrupts.
 - Device wake up function.
 - Supports software compensation of crystal frequency by compensation register (FCR)
- PWM/Capture
 - Built-in up to two 16-bit PWM generators provide two PWM outputs or one complementary paired PWM outputs.
 - The PWM generator equipped with a clock source selector, a clock divider, an 8-bit pre-scaler and Dead-Zone generator for complementary paired PWM.
 - PWM interrupt synchronous to PWM period.
 - 16-bit digital Capture timers (shared with PWM timers) provide rising/falling capture inputs.
 - Support Capture interrupt
- UART
 - UART ports with flow control (TX, RX, CTS and RTS)
 - 8-Byte FIFO.
 - Support IrDA (SIR) and LIN function
 - Programmable baud-rate generator up to 1/16 of system clock.
- SPI
 - Master up to 20 Mbps / Slave up to 10 Mbps.
 - Support MICROWIRE/SPI master/slave mode (SSP)
 - Full duplex synchronous serial data transfer
 - Variable length of transfer data from 1 to 32 bits
 - MSB or LSB first data transfer
 - 2 slave/device select lines when used in master mode.
 - Hardware CRC calculation module available for CRC calculation of data stream.

- DMA support for burst transfers.
- I²C
 - Master/Slave up to 1Mbit/s
 - Bidirectional data transfer between masters and slaves
 - Multi-master bus (no central master).
 - Arbitration between simultaneously transmitting masters without corruption of serial data on the bus
 - Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
 - Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
 - Programmable clock allowing versatile rate control.
 - I²C -bus controller supports multiple address recognition.
- I²S
 - Interface with external audio CODEC.
 - Operate as either master or slave.
 - Capable of handling 8, 16, 24 and 32 bit word sizes
 - Mono and stereo audio data supported
 - I²S and MSB justified data format supported
 - Two 8 word FIFO data buffers are provided, one for transmit and one for receive
 - Generates interrupt requests when buffer levels cross a programmable boundary
 - Supports DMA requests, for transmit and receive
- Brown-out detector
 - With 8 levels: 2.1V, 2.2V, 2.4V, 2.5V, 2.625V, 2.8V, 3.0V, and 4.6V
 - Supports time-multiplex operation to minimize power consumption.
 - Supports Brownout Interrupt and Reset option
- Built in Low Dropout Voltage Regulator (LDO)
 - Capable of delivering 30mA load current.
 - Configurable for output voltage of 1.8V, 2.4V, 3.0V and 3.3V
 - Eight GPIO (GPIOA<7:0>) operate from LDO voltage domain allowing direct interface to, for example, 3V SPI Flash.
 - Can be bypassed and voltage domain supplied directly from system power.
- Additional Features
 - Over temperature alarm. Can generate interrupt if device exceeds safe operating temperature.
 - Temperature proportional voltage source which can be routed to ADC for temperature measurements.
 - Digital Microphone interface.
- Operating Temperature: -20°C ~ 85°C

3 PAD DESCRIPTION

Pin Name	Pin Type	Alt CFG	Description
WAKEUP	I		Pull low to wake part from deep power down
PB.7	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 7
I ² S_SDO	O	1	Serial Data Output for I ² S interface
CMP7	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
PB.6	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 6
I ² S_SDI	I	1	Serial Data Input for I ² S interface
CMP6	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_MOSI1	O	3	Master Out, Slave In channel 1 for SPI interface
PB.5	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 5
PWM1B	O	1	PWM channel 1 complementary output pin
CMP5	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_MISO1	I	3	Master In, Slave Out channel 1 for SPI interface
PB.4	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 4
PWM0B	O	1	PWM channel 0 complementary output pin
CMP4	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_MOSI0	O	3	Master Out, Slave In channel 0 for SPI interface
PB.3	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 3
I ² C_SDA	I/O	1	Serial Data, I ² C interface
CMP3	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_MISO0	I	3	Master In, Slave Out channel 0 for SPI interface
PB.2	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 2
I ² C_SCL	I/O	1	Serial Clock, I ² C interface

Pin Name	Pin Type	Alt CFG	Description
CMP2	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_SCLK	I/O	3	Serial Clock for SPI interface
PB.1	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 1. Triggers external interrupt 1 (EINT1/IRQ3)
MCLK	O	1	Master clock output for synchronizing external device
CMP1	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_SSB1	O	3	Slave Select Bar 1 for SPI interface
PB.0	A/I/O	0	General purpose input/output pin, analog capable; Port B, bit 0. Triggers external interrupt 0 (EINT0/IRQ2)
SPI_SSB1	O	3	Slave Select Bar 1 for SPI interface
CMP0	AIO	2	Configure as relaxation oscillator for capacitive touch sensing
SPI_SSB0	I/O	3	Slave Select Bar 0 for SPI interface
VCCD	P		Main Digital Supply for Chip. Supplies all IO except analog, Speaker Driver and PA<7:0>
VREG	P		Logic regulator output decoupling pin. A 1µF capacitor returning to VSSD must be placed on this pin.
NC			Should remain unconnected.
NC			Should remain unconnected.
PA.15	I/O	0	General purpose input/output pin; Port A, bit 15
TM1	I	1	External input to Timer 1
SDIN	I	2	Sigma Delta bit stream input for digital MIC mode
PA.9	I/O	0	General purpose input/output pin; Port A, bit 9
UART_RX	I	1	Receive channel of UART
I ² S_BCLK	I/O	2	Bit Clock for I ² S interface
PA.8	I/O	0	General purpose input/output pin; Port A, bit 8
UART_TX	O	1	Transmit channel of UART
I ² S_FS	I/O	2	Frame Sync Clock for I ² S interface
VCCSPK	P		Power Supply for PWM Speaker Driver
SPK+	O		Positive Speaker Driver Output
VSSSPK	P		Ground for PWM Speaker Driver
SPK-	O		Negative Speaker Driver Output

Pin Name	Pin Type	Alt CFG	Description
VCCSPK	P		Power Supply for PWM Speaker Driver
RESETN	I		External reset input. Pull this pin low to reset device to initial state. Has internal weak pull-up.
ICE_DAT	I/O		Serial Wire Debug port data pin. Has internal weak pull-up.
ICE_CLK	I		Serial Wire Debug port clock pin. Has internal weak pull-up.
VSSD	P		Digital Ground.
PA.7	I/O	0	General purpose input/output pin; Port A, bit 7
I ² S_SDO	O	1	Serial Data Out for I ² S interface
PA.6	I/O	0	General purpose input/output pin; Port A, bit 6
I ² S_SDI	I	1	Serial Data In for I ² S interface
PA.5	I/O	0	General purpose input/output pin; Port A, bit 5
I ² S_BCLK	I/O	1	Bit Clock for I ² S interface
PA.4	I/O	0	General purpose input/output pin; Port A, bit 4
I ² S_FS	I/O	1	Frame Sync Clock for I ² S interface
PA.3	I/O	0	General purpose input/output pin; Port A, bit 3
SPI_MISO0	I	1	Master In, Slave Out channel 0 for SPI interface
I ² C_SDA	I/O	2	Serial Data, I ² C interface
PA.2	I/O	0	General purpose input/output pin; Port A, bit 2
SPI_SSB0	I/O	1	Slave Select Bar 0 for SPI interface
VDD33	P		LDO Regulator Output. If used, a 1 μ F capacitor must be placed to ground. If not used then tie to VCCD.
PA.1	I/O	0	General purpose input/output pin; Port A, bit 1
SPI_SCLK	I/O	1	Serial Clock for SPI interface
I ² C_SCL	I/O	2	Serial Clock, I ² C interface
PA.0	I/O	0	General purpose input/output pin; Port A, bit 2
SPI_MOSI0	O	1	Master Out, Slave In channel 0 for SPI interface
MCLK	O	2	Master clock output.
VCCLDO	P		Power Supply for LDO, should be connected to VCCD
PA.14	I/O	0	General purpose input/output pin; Port A, bit 14
SDCLK	O	1	Clock output for digital microphone mode.
SDCLKn	O	2	Inverse Clock output for digital microphone mode.

Pin Name	Pin Type	Alt CFG	Description
PA.13	I/O	0	General purpose input/output pin; Port A, bit 13
PWM1	O	1	PWM1 Output.
SPKM	O	2	Equivalent to SPK-.
I ² S_BCLK	I/O	3	Bit Clock for I ² S interface
PA.12	I/O	0	General purpose input/output pin; Port A, bit 12
PWM0	O	1	PWM0 Output.
SPKP	O	2	Equivalent to SPK+
I ² S_FS	I/O	3	Frame Sync Clock for I ² S interface
XO32K	O		32.768 KHz Crystal Oscillator Output
XI32K	I		32.768 KHz Crystal Oscillator Input. Max Voltage 1.8V
VSSA	AP		Ground for analog circuitry.
VMID	O		Mid rail reference. Connect 4.7μF to VSSA.
MIC+	AI		Positive microphone input.
MIC-	AI		Negative microphone input.
MICBIAS	AO		Microphone bias output.
VCCA	AP		Analog power supply.
PA.11	I/O	0	General purpose input/output pin; Port A, bit 11
I ² C_SCL	I/O	1	Serial Clock, I ² C interface
I ² S_SDO	O	2	Serial Data Out I ² S interface
UART_CTSn	I	3	UART Clear to Send Input.
PA.10	I/O	0	General purpose input/output pin; Port A, bit 10
I ² C_SDA	I/O	1	Serial Data, I ² C interface
I ² S_SDI	I	2	Serial Data In I ² S interface
UART_RTSn	O	3	UART Request to Send Output.

Note:

- PAD Type I=Digital Input, O=Digital Output; AI=Analog Input; P=Power PAD; AP=Analog Power

4 BLOCK DIAGRAM

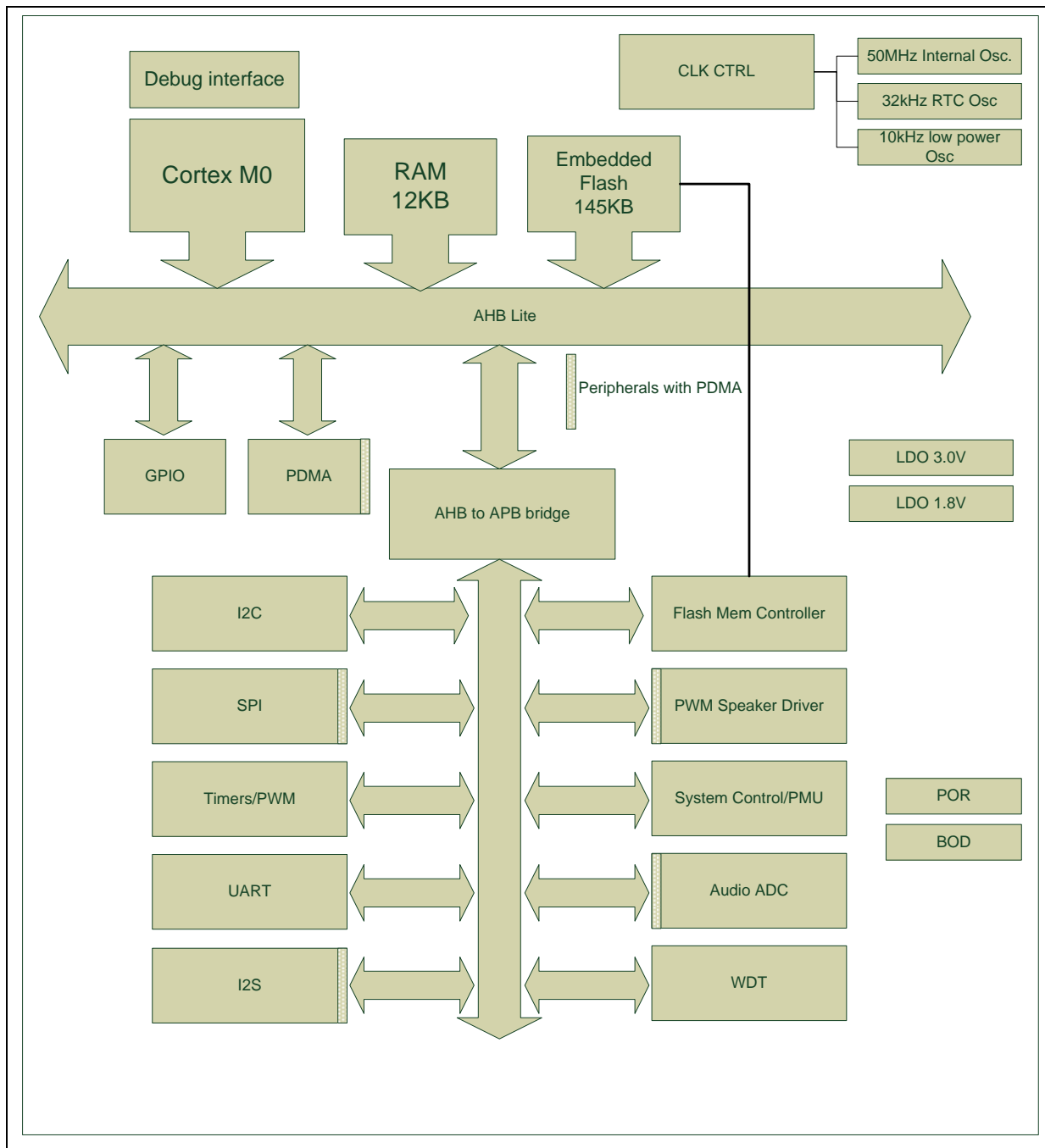
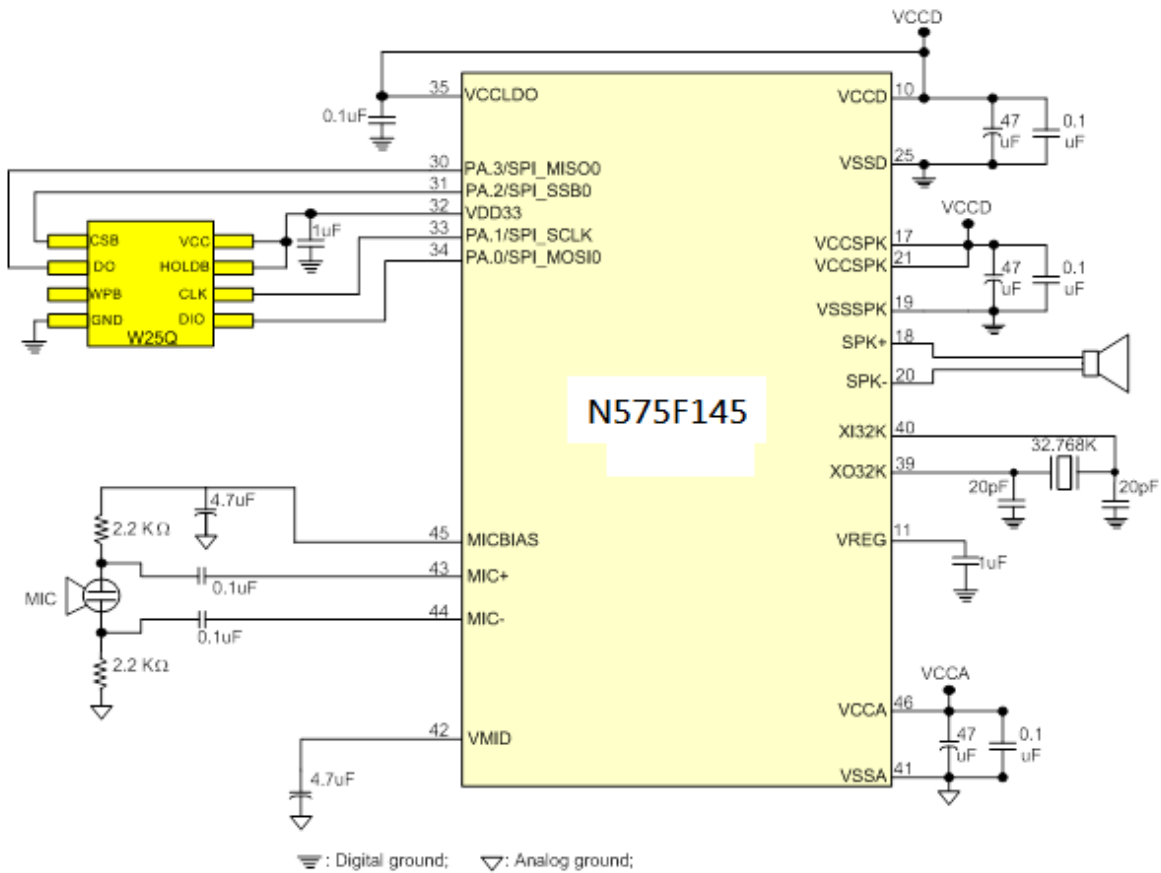


Figure 4-1 N575F145 Block Diagram

5 APPLICATION DIAGRAM



6 ELECTRICAL CHARACTERISTICS

6.1 Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Unit	
	DC Power Supply	VDD-VSS	-0.3	+6.0	V
	Input Voltage	VIN	VSS-0.3	VDD+0.3	V
	Oscillator Frequency	1/t _{CLCL}	0	40	MHz
	Operating Temperature	TA	-40	+85	°C
	Storage Temperature	TST	-55	+150	°C
	Maximum Current into V _{DD}		-	120	mA
	Maximum Current out of V _{SS}			120	mA
	Maximum Current sunk by a I/O pin			35	mA
	Maximum Current sourced by a I/O pin			35	mA
	Maximum Current sunk by total I/O pins			100	mA
	Maximum Current sourced by total I/O pins			100	mA

Note: Exposure to conditions beyond those listed under absolute maximum ratings may adversely affects the life and reliability of the device.

6.2 DC Electrical Characteristics

(VDD-VSS=3.3V, TA = 25°C, FOSC = 49.152 MHz unless otherwise specified.)

Parameter	Sym	Specification				Test Conditions
		Min	Typ	Max	Unit	
Operation voltage	V _{DD}	2.4		5.5	V	V _{DD} =2.4V ~ 5.5V up to 49 MHz
Power Ground	V _{SS} AV _{SS}	-0.3			V	
Analog Operating Voltage	AV _{DD}	0		V _{DD}	V	
Analog Reference Voltage	V _{ref}	0		AV _{DD}	V	
Operating Current Normal Run Mode @ 49.152 MHz	I _{DD1}		24.8		mA	V _{DD} = 5.5V, Enable all IP.
	I _{DD2}		19.7		mA	V _{DD} =5.5V, disable all IP
	I _{DD3}		23.6		mA	V _{DD} = 3V, enable all IP
	I _{DD4}		18.3		mA	V _{DD} = 3V, disable all IP
Operating Current Normal Run Mode @ 32.768 MHz	I _{DD5}		18.8		mA	V _{DD} = 5.5V, Enable all IP.
	I _{DD6}		15.0		mA	V _{DD} = 5.5V, Disable all IP.
	I _{DD7}		17.6		mA	V _{DD} = 3V, Enable all IP.
	I _{DD8}		13.8		mA	V _{DD} = 3V, Disable all IP.

Operating Current Normal Run Mode @ 12.288 MHz	I _{DD9}		12.5		mA	V _{DD} = 5.5V enable all IP
	I _{DD10}		10.3		mA	V _{DD} = 5.5V, disable all IP
	I _{DD11}		11.4		mA	V _{DD} = 3V enable all IP
	I _{DD12}		9		mA	V _{DD} = 3V, disable all
Operating Current Normal Run Mode @ 4.9152 MHz	I _{DD13}		9.7		mA	V _{DD} = 5.5V, Enable all IP.
	I _{DD14}		8.1		mA	V _{DD} = 5.5V, Disable all IP.
	I _{DD15}		8.7		mA	V _{DD} = 3V, Enable all IP.
	I _{DD16}		7.0		mA	V _{DD} = 3V, Disable all IP.
Operating Current Sleep Mode	I _{IDLE1}		10		mA	V _{DD} = 5.5V
	I _{IDLE1}		9		mA	V _{DD} = 3.3V
Operating Current Deep Sleep Mode	I _{IDLE1}		10		mA	V _{DD} =5.5V
	I _{IDLE1}		8		mA	V _{DD} = 3.3V
Standby Power down mode(SPD)	I _{IDLE1}		3		uA	V _{DD} =3.3V 32K running with RTC
	I _{IDLE1}		1		uA	V _{DD} = 3.3V 16K running
Operating Current Deep Power down mode(DPD)	I _{IDLE1}		500		nA	V _{DD} =3.3V Wakeup with16K
	I _{IDLE1}				nA	V _{DD} = 3.3V wakeup with wakeup pin

Input Current PA, PB (Quasi-bidirectional mode)	I_{IN1}	-60	-	+15	μA	$V_{DD} = 5.5V, V_{IN} = 0V$ or $V_{IN}=V_{DD}$
Input Current at /RESET ^[1]	I_{IN2}	-55	-45	-30	μA	$V_{DD} = 3.3V, V_{IN} = 0.45V$
Input Leakage Current PA, PB	I_{LK}	-2	-	+2	μA	$V_{DD} = 5.5V, 0 < V_{IN} < V_{DD}$
Logic 1 to 0 Transition Current PA~PB (Quasi-bidirectional mode)	$I_{TL}^{[3]}$	-650	-	-200	μA	$V_{DD} = 5.5V, V_{IN} < 2.0V$
Input Low Voltage PA, PB (TTL input)	V_{IL1}	-0.3	-	0.8	V	$V_{DD} = 4.5V$
		-0.3	-	0.6		$V_{DD} = 2.5V$
Input High Voltage PA, PB (TTL input)	V_{IH1}	2.0	-	$V_{DD} + 0.2$	V	$V_{DD} = 5.5V$
		1.5	-	$V_{DD} + 0.2$		$V_{DD} = 3.0V$
Input Low Voltage XT1 ^[2]	V_{IL3}	0	-	0.8	V	$V_{DD} = 4.5V$
		0	-	0.4		$V_{DD} = 3.0V$
Input High Voltage XT1 ^[2]	V_{IH3}	3.5	-	$V_{DD} + 0.2$	V	$V_{DD} = 5.5V$
		2.4	-	$V_{DD} + 0.2$		$V_{DD} = 3.0V$
Input Low Voltage X321 ^[2]	V_{IL4}	0	-	0.4	V	
Input High Voltage X321 ^[2]	V_{IH4}	1.7		2.5	V	
Negative going threshold (Schmitt input), /REST	V_{ILS}	-0.5	-	$0.3V_{DD}$	V	
Positive going threshold (Schmitt input), /REST	V_{IHS}	$0.7V_{DD}$	-	$\frac{V_{DD} + 0.5}{5}$	V	
Hysteresis voltage of PA~PB(Schmitt input)	V_{HY}		$0.2V_{DD}$		V	

Source Current PA, PB (Quasi-bidirectional Mode)	I _{SR11}	-300	-370	-450	μA	V _{DD} = 4.5V, V _S = 2.4V
	I _{SR12}	-50	-70	-90	μA	V _{DD} = 2.7V, V _S = 2.2V
	I _{SR12}	-40	-60	-80	μA	V _{DD} = 2.5V, V _S = 2.0V
Source Current PA, PB (Push-pull Mode)	I _{SR21}	-20	-24	-28	mA	V _{DD} = 4.5V, V _S = 2.4V
	I _{SR22}	-4	-6	-8	mA	V _{DD} = 2.7V, V _S = 2.2V
	I _{SR22}	-3	-5	-7	mA	V _{DD} = 2.5V, V _S = 2.0V
Sink Current PA, PB (Quasi-bidirectional and Push-pull Mode)	I _{SK1}	10	16	20	mA	V _{DD} = 4.5V, V _S = 0.45V
	I _{SK1}	7	10	13	mA	V _{DD} = 2.7V, V _S = 0.45V
	I _{SK1}	6	9	12	mA	V _{DD} = 2.5V, V _S = 0.45V
Brownout voltage with BOV_VL [2:0] =000b	V _{BO2.1}		2.15		V	
Brownout voltage with BOV_VL [2:0] =001b	V _{BO2.2}		2.25		V	
Brownout voltage with BOV_VL [2:0] =010b	V _{BO2.4}		2.45		V	
Brownout voltage with BOV_VL [2:0] =011b	V _{BO2.5}		2.55		V	
Brownout voltage with BOV_VL [2:0] =100b	V _{BO2.7}		2.7		V	
Brownout voltage with BOV_VL [2:0] =101b	V _{BO2.8}		2.8		V	
Brownout voltage with BOV_VL [2:0] =110b	V _{BO3.0}		3.0		V	
Brownout voltage with BOV_VL [2:0] =111b	V _{BO4.5}		4.55		V	

Notes:

1. /RESET pin is a Schmitt trigger input.
2. Crystal Input is a CMOS input.

6.3 AC Electrical Characteristics

6.3.1 External 32 KHz XTAL Oscillator

Parameter	Condition	Min	Typ	Max	Unit
Input clock frequency	External crystal	-	32.768	-	KHz
Temperature	-	-40	-	85	°C
V _{DD}	-	2.4	-	5.5	V

6.3.2 Internal 49.152 MHz Oscillator

Parameter	Condition	Min	Typ	Max	Unit
Supply voltage ^[1]	-	2.4	-	5.5	V
Center Frequency	-	-	49.152	-	MHz
Calibrated Internal Oscillator Frequency	+25°C; V _{DD} =5V	-1	-	1	%
	-40°C ~ +85°C; V _{DD} =2.5V~5.5V	-4	-	4	%

6.3.3 Internal 16 KHz Oscillator

Parameter	Condition	Min	Typ	Max	Unit
Supply voltage	-	2.4	-	5.5	V
Center Frequency	-	-	10	-	KHz
Calibrated Internal Oscillator Frequency	+25°C; V _{DD} =5V	-10	-	10	%
	-40°C ~ +85°C; V _{DD} =2.5V~5.5V	-20	-	20	%

Notes:

*1. Internal operation voltage comes from LDO.

6.3.4 Reset Characteristics

(V_{DD}-V_{SS}=5V, T_A = 25°C, F_{OSC} = 49.152 MHz unless otherwise specified.)

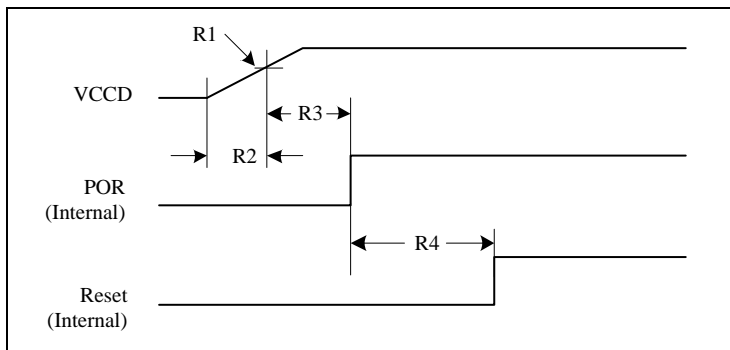
Parameter No.	Parameter	Parameter Name	Min	Typ	Max	Unit
R1	V _{TH}	Reset threshold	1	1.7	2	V
R2	T _{VDDRISE}	Supply voltage (V _{DD}) rise time (0V-5V), power on reset	-	-	100	ms
R3	T _{POR}	Power-On Reset timeout	-	-	12	µs
R4	T _{IRPOR}	Internal reset timeout after POR	-	-	45	µs
R5	T _{MIN}	Minimum RESETN pulse width	100	-	-	ns
R6	T _{IRHWR}	Internal reset timeout after hardware reset (RESETN pin)	-	-	20	µs

R7	TIRSWR	Internal reset timeout after software-initiated system reset	-	-	2	μs
R8	TIRWDR	Internal reset timeout after watchdog reset	-	-	3 * ²	μs

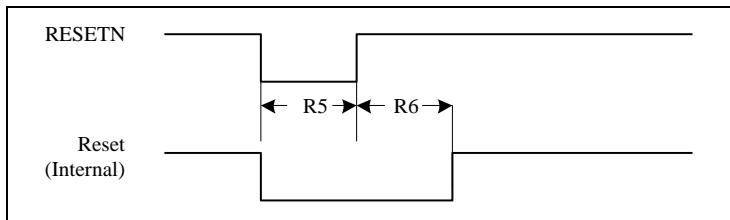
***Notes:**

2. It will be 6500us when use OSC_10K as the WDG clock.

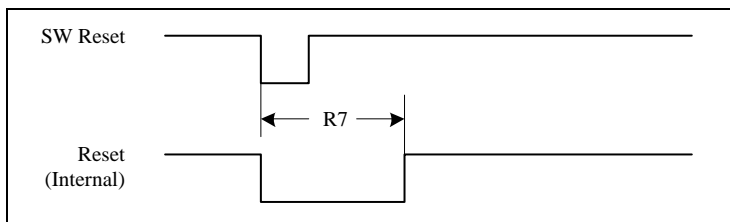
6.3.4.1 Power-On Reset Timing



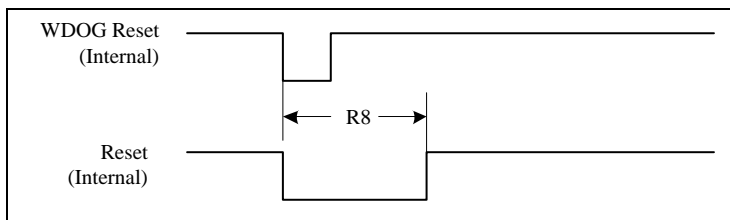
6.3.4.2 External Reset Timing (RESETN)



6.3.4.3 Software Reset Timing



6.3.4.4 Watchdog Reset Timing



7 ORDERING INFORMATION

Die form: N575F145 (Blank)

Die form: N575F145xxxx (Pre-code)

8 REVISION HISTORY

Version	Date	Substantial Changes	Page
A1.0	July 2015	Initial Release	
A1.1	Sep. 2015	Remove package form	All

Important Notice

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Insecure usage includes, but is not limited to: equipment for surgical implementation, atomic energy control instruments, airplane or spaceship instruments, the control or operation of dynamic, brake or safety systems designed for vehicular use, traffic signal instruments, all types of safety devices, and other applications intended to support or sustain life.

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